

N-Channel Super Junction Power MOSFET III

General Description

The series of devices use advanced trench gate super junction technology and design to provide excellent R_{DS(ON)} with low gate charge. This super junction MOSFET fits the industry's AC-DC SMPS requirements for PFC, AC/DC power conversion, and industrial power applications.

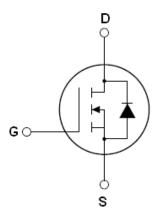
Features

- Optimized body diode reverse recovery performance
- ●Low on-resistance and low conduction losses
- ●Small package
- ●Ultra Low Gate Charge cause lower driving requirements
- ●100% Avalanche Tested
- ROHS compliant

Application

- Power factor correction (PFC)
- Switched mode power supplies(SMPS)
- Uninterruptible Power Supply (UPS)
- LLC Half-bridge

V _{DS}	650	V
R _{DS(ON)TYP}	290	mΩ
I_{D}	11.5	A



Schematic diagram

Package Marking And Ordering Information

Device	Device Package	Marking
NCE65TF360D	TO-263	NCE65TF360D
NCE65TF360	TO-220	NCE65TF360
NCE65TF360F	TO-220F	NCE65TF360F







TO-263

TO-220

TO-220F

v1.1

Table 1. Absolute Maximum Ratings (T_c=25℃)

Parameter	Symbol	NCE65TF360D NCE65TF360	NCE65TF360F	Unit	
Drain-Source Voltage (VGS=0V)	V _{DS}	65	50	V	
Gate-Source Voltage (VDS=0V), AC(f>1HZ)	V _G s	±	30	V	
Continuous Drain Current at T _C =25°C	I _{D (DC)}	11.5	11.5*	Α	
Continuous Drain Current at T _C =100°C	I _{D (DC)}	7	7*	Α	
Pulsed drain current (Note 1)	I _{DM (pluse)}	46	46*	Α	
Maximum Power Dissipation(T _C =25℃)	P _D	101 32.6		W	
Derate above 25°C		0.81	0.26	w/°C	
Single pulse avalanche energy (Note2)	Eas	144		mJ	
Avalanche current ^(Note 1)	I _{AR}	6		Α	
Repetitive Avalanche energy , t_{AR} limited by T_{jmax} (Note 1)	E _{AR}	0.5		mJ	



Parameter	Symbol	NCE65TF360D NCE65TF360	NCE65TF360F	Unit
Drain Source voltage slope, V _{DS} ≤480 V,	dv/dt	50		V/ns
Reverse diode dv/dt, $V_{DS} \leq 480 \text{ V,I}_{SD} < I_{D}$	dv/dt	50		V/ns
Operating Junction and Storage Temperature Range	T_{J} , T_{STG}	-55	+150	°C

^{*} limited by maximum junction temperature

Table 2. Thermal Characteristic

Parameter	Symbol	NCE65TF360D NCE65TF360	NCE65TF360F	Unit
Thermal Resistance, Junction-to-Case (Maximum)	R _{thJC}	1.24	3.83	°C /W
Thermal Resistance, Junction-to-Ambient (Maximum)	R _{thJA}	62	80	°C /W

Table 3. Electrical Characteristics (TA=25°C unless otherwise noted)

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Parameter	Symbol	Condition	Min	Тур	Max	Unit
On/off states						
Drain-Source Breakdown Voltage	BV _{DSS}	V _{GS} =0V I _D =250μA	650			V
Zero Gate Voltage Drain Current(Tc=25℃)	I _{DSS}	V _{DS} =650V,V _{GS} =0V			2	μΑ
Zero Gate Voltage Drain Current(Tc=125℃)	I _{DSS}	V _{DS} =650V,V _{GS} =0V			100	μΑ
Gate-Body Leakage Current	I _{GSS}	V _{GS} =±20V,V _{DS} =0V			±100	nA
Gate Threshold Voltage	V _{GS(th)}	V _{DS} =V _{GS} ,I _D =250μA	3	3.5	4	V
Drain-Source On-State Resistance	R _{DS(ON)}	V _{GS} =10V, I _D =7A		290	360	mΩ
Dynamic Characteristics						
Input Capacitance	C _{lss}	\/ -50\/\/ -0\/		870		pF
Output Capacitance	Coss	V_{DS} =50V, V_{GS} =0V, F=1.0MHz		54		pF
Reverse Transfer Capacitance	C _{rss}	F=1.UIVITZ		1.8		pF
Total Gate Charge	Qg	\/ -400\/ -44.54		19		nC
Gate-Source Charge	Q _{gs}	V _{DS} =480V,I _D =11.5A, V _{GS} =10V		6		nC
Gate-Drain Charge	Q _{gd}	VGS=10V		6.5		nC
Switching times						
Turn-on Delay Time	t _{d(on)}			11		nS
Turn-on Rise Time	t _r	V_{DD} =380V, I_{D} =5.5A,		8		nS
Turn-Off Delay Time	t _{d(off)}	$R_G=3\Omega,V_{GS}=10V$		58	70	nS
Turn-Off Fall Time	t _f			9	14	nS
Source- Drain Diode Characteristics						
Source-drain current(Body Diode)	I _{SD}	T _C =25°C			11.5	Α
Pulsed Source-drain current(Body Diode)	I _{SDM}	10-25 C			46	Α
Forward on voltage	V _{SD}	Tj=25°C,I _{SD} =11.5A,V _{GS} =0V		0.9	1.2	V
Reverse Recovery Time	t _{rr}	T:-25°C -5 0A		130		nS
Reverse Recovery Charge	Q _{rr}	Tj=25°C,I _F =5.8A,		0.72		uC
Peak Reverse Recovery Current	I _{rrm}	di/dt=100A/μs		11		Α

Notes: 1.Repetitive Rating: Pulse width limited by maximum junction temperature

2. Tj=25°C,VDD=50V,VG=10V, R_G=25 Ω



TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS (curves)

Figure 1. Safe operating area

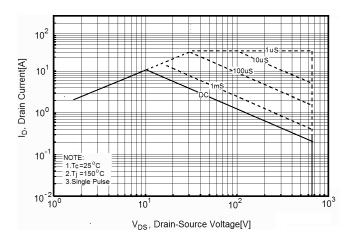


Figure 2. Safe operating area for TO-220F

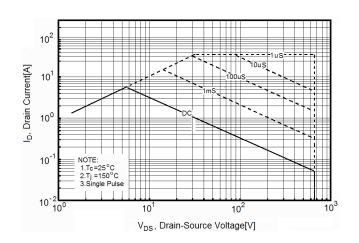


Figure 3. Source-Drain Diode Forward Voltage

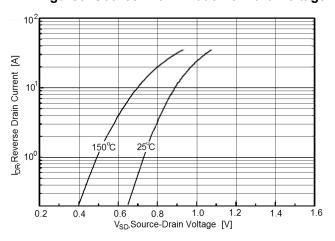


Figure 4. Output characteristics

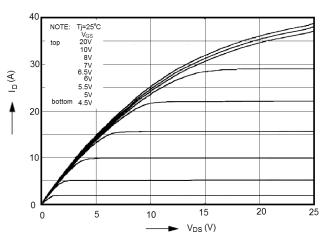


Figure 5. Transfer characteristics

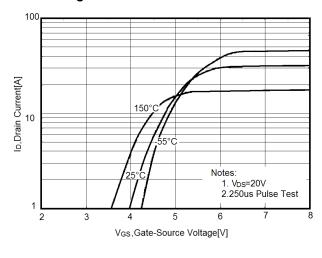


Figure 6. Static drain-source on resistance

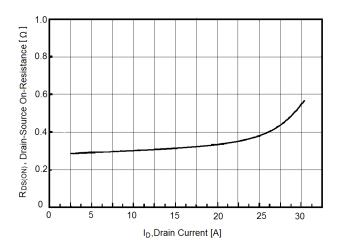




Figure 7. R_{DS(ON)} vs Junction Temperature

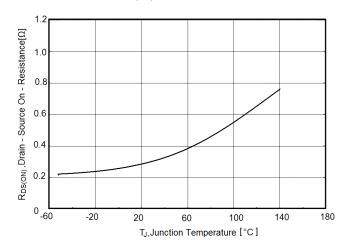


Figure8. BV_{DSS} vs Junction Temperature

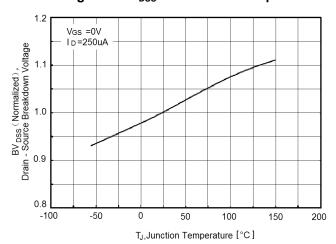


Figure 9. Maximum ID vs Junction Temperature

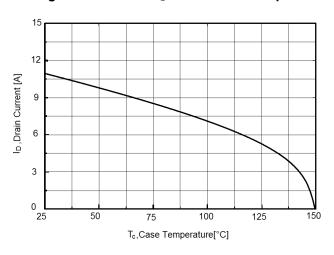


Figure 10. Gate charge waveforms

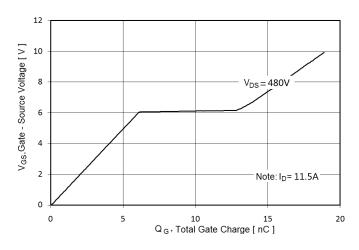


Figure11. Capacitance

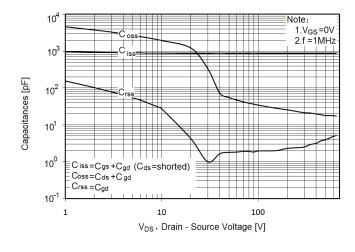
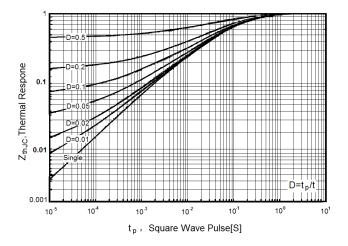


Figure 12. Transient Thermal Impedance

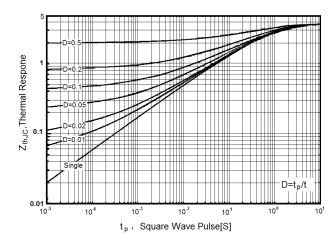




Wuxi NCE Power Co., Ltd

${\tt NCE65TF360D,NCE65TF360,NCE65TF360F}$

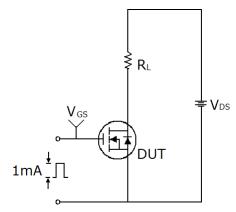
Figure 13. Transient Thermal Impedance for TO-220F

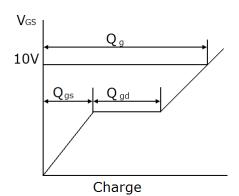




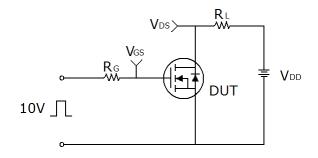
Test circuit

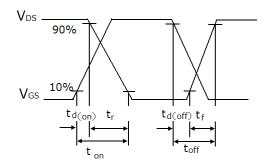
1) Gate charge test circuit & Waveform



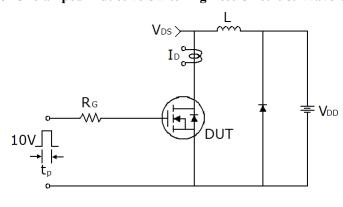


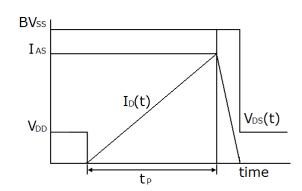
2) Switch Time Test Circuit:





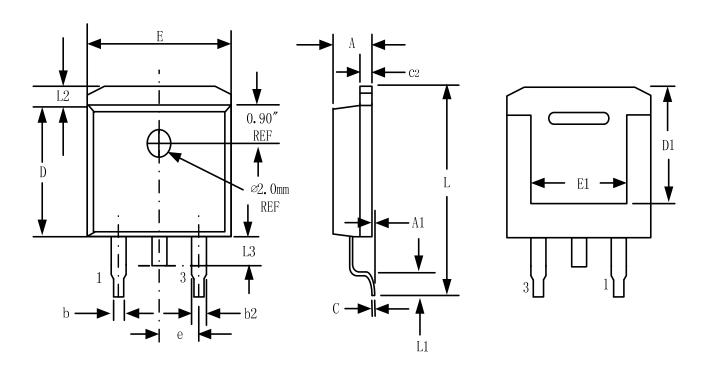
3) Unclamped Inductive Switching Test Circuit & Waveforms







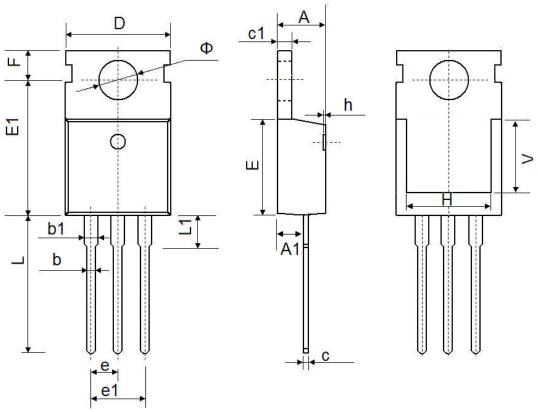
TO-263-3L Package Information



Symph of	Dimensions	In Millimeters	Dimension	Dimensions In Inches		
Symbol	Min.	Max.	Min.	Max.		
А	4.32	4.57	0.170	0.180		
A1	-	0.25		0.010		
b	0.71	0.94	0.028	0.037		
b2	1.15	1.40	0.045	0.055		
С	0.46	0.61	0.018	0.024		
c2	1.22	1.40	0.048	0.055		
D	8.89	9.40	0.350	0.370		
D1	8.01	8.23	0.315	0.324		
E	10.04	10.28	0.395	0.405		
E1	7.88	8.08	0.310	0.318		
е	2.54	BSC	0.100	BSC		
L	14.73	15.75	0.580	0.620		
L1	2.29	2.79	0.090	0.110		
L2	1.15	1.39	0.045	0.055		
L3	1.27	1.77	0.050	0.070		



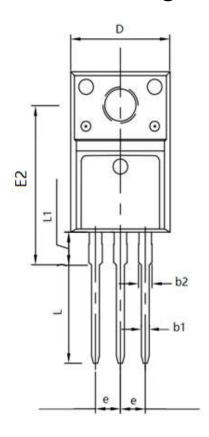
TO-220-3L-C Package Information

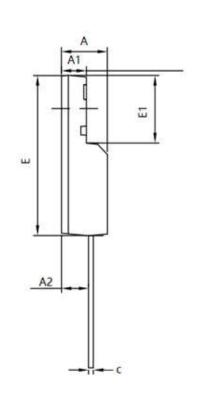


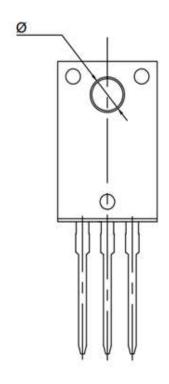
Comment of	Dimensions	In Millimeters	Dimensions In Inches		
Symbol	Min.	Max.	Min.	Max.	
А	4.400	4.600	0.173	0.181	
A1	2.250	2.550	0.089	0.100	
b	0.710	0.910	0.028	0.036	
b1	1.170	1.370	0.046	0.054	
С	0.330	0.650	0.013	0.026	
c1	1.200	1.400	0.047	0.055	
D	9.910	10.250	0.390	0.404	
Е	8.9500	9.750	0.352	0.384	
E1	12.650	12.950	0.498	0.510	
е	2.540	TYP.	0.100	TYP.	
e1	4.980	5.180	0.196	0.204	
F	2.650	2.950	0.104	0.116	
Н	7.900	8.100	0.311	0.319	
h	0.000	0.300	0.000	0.012	
L	12.900	13.400	0.508	0.528	
L1	2.850	3.250	0.112	0.128	
V	7.500	REF.	0.295	REF.	
Ф	3.400	3.800	0.134	0.150	



TO-220F Package Information







Symbol	Dimensions	Dimensions In Millimeters		In Inches
	Min.	Max.	Min.	Max.
Α	4.500	4.900	0.177	0.193
A1	2.340	2.740	0.092	0.108
A2	2.560	2.960	0.101	0.117
b1	0.700	0.900	0.028	0.035
b2	1.180	1.580	0.046	0.062
С	0.400	0.600	0.016	0.024
D	9.960	10.360	0.392	0.408
E	15.670	15.970	0.617	0.629
E1	6.500	6.900	0.256	0.272
E2	15.500	16.100	0.610	0.634
е	2.54	0 TYP	0.100	TYP
Ф	3.080	3.280	0.121	0.129
L	12.640	13.240	0.498	0.521
L1	3.030	3.430	0.119	0.135



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